



Is Now Part of



**ON Semiconductor®**

To learn more about ON Semiconductor, please visit our website at  
[www.onsemi.com](http://www.onsemi.com)

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at [www.onsemi.com](http://www.onsemi.com). Please email any questions regarding the system integration to [Fairchild\\_questions@onsemi.com](mailto:Fairchild_questions@onsemi.com).

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.



# FSL137H

## Green Mode Fairchild Power Switch (FPS™)

### Features

- Built-in 5ms Soft-Start Function
- Internal Avalanche Rugged 700V SenseFET
- Low Audio Noise
- High-Voltage Startup
- Fixed PWM Frequency at 100KHz
- Linearly Decreasing PWM Frequency to 18KHz
- Peak-Current-Mode Control
- Cycle-by-Cycle Current Limiting
- Leading-Edge Blanking (LEB)
- Synchronized Slope Compensation
- Internal Open-loop Protection (OLP)
- V<sub>DD</sub> Under-Voltage Lockout (UVLO)
- V<sub>DD</sub> Over-Voltage Protection (OVP)
- Constant Power Limit (Full AC Input Range)
- Internal OTP Sensor with Hysteresis

### Applications

General-purpose switch-mode power supplies and flyback power converters, including:

- SMPS for VCR, SVR, STB, DVD & VCD Player, Printer, Facsimile, & Scanner
- Adapter for Camcorder

### Description

The highly integrated FSL137H consists of an integrated current mode Pulse Width Modulator (PWM) and an avalanche-rugged 700V SenseFET. It is specifically designed for high-performance offline Switch Mode Power Supplies (SMPS) with minimal external components.

The integrated PWM controller features include a proprietary green-mode function that provides off-time modulation to linearly decrease the switching frequency at light-load conditions to minimize standby power consumption. To avoid acoustic noise problems, the minimum PWM frequency is set above 18KHz. The green-mode function enables the power supply to meet international power conservation requirements. With the internal high-voltage startup circuitry, the power loss due to bleeding resistors is also eliminated. To further reduce power consumption, the PWM controller is manufactured using the BiCMOS process, which allows an operating current of only 3.5mA.

The FSL137H built-in synchronized slope compensation achieves stable peak-current-mode control. The proprietary external line compensation ensures constant output power limit over a wide AC input voltage range, from 90V<sub>AC</sub> to 264V<sub>AC</sub>.

The FSL137H provides many protection functions. In addition to cycle-by-cycle current limiting, the internal open-loop protection circuit ensures safety when an open-loop or output short-circuit failure occurs. PWM output is disabled until V<sub>DD</sub> drops below the UVLO lower limit, when the controller starts up again. As long as V<sub>DD</sub> exceeds ~28V, the internal OVP circuit is triggered.

Compared to a discrete MOSFET and controller or RCC switching converter solution, the FSL137H reduces total component count, design size, and weight while increasing efficiency, productivity, and system reliability. These devices provide a basic platform well suited for design of cost-effective flyback converters.

### Ordering Information

Part Number	SenseFET	Operating Temperature Range	Package	Packing Method
FSL137HNY	3.0A 700V	-40°C to +105°C	8-Pin Dual In-Line Package (DIP)	Tube

## Application Diagram

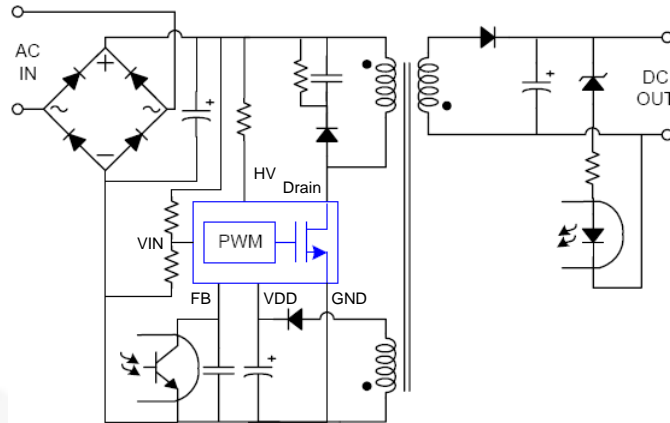


Figure 1. Typical Flyback Application

## Output Power Table<sup>(1)</sup>

Product	230V <sub>AC</sub> ± 15% <sup>(2)</sup>		85-265V <sub>AC</sub>	
	Adapter <sup>(3)</sup>	Open Frame <sup>(4)</sup>	Adapter <sup>(3)</sup>	Open Frame <sup>(4)</sup>
FSL137H	17.5W	25W	13W	19W

### Notes:

1. The maximum output power can be limited by junction temperature.
2. 230 V<sub>AC</sub> or 100/115 V<sub>AC</sub> with doublers.
3. Typical continuous power in a non-ventilated enclosed adapter with sufficient drain pattern as a heat sink, at T<sub>A</sub>=50°C ambient.
4. Maximum practical continuous power in an open-frame design with sufficient drain pattern as a heat sink, at T<sub>A</sub>=50°C ambient.

## Internal Block Diagram

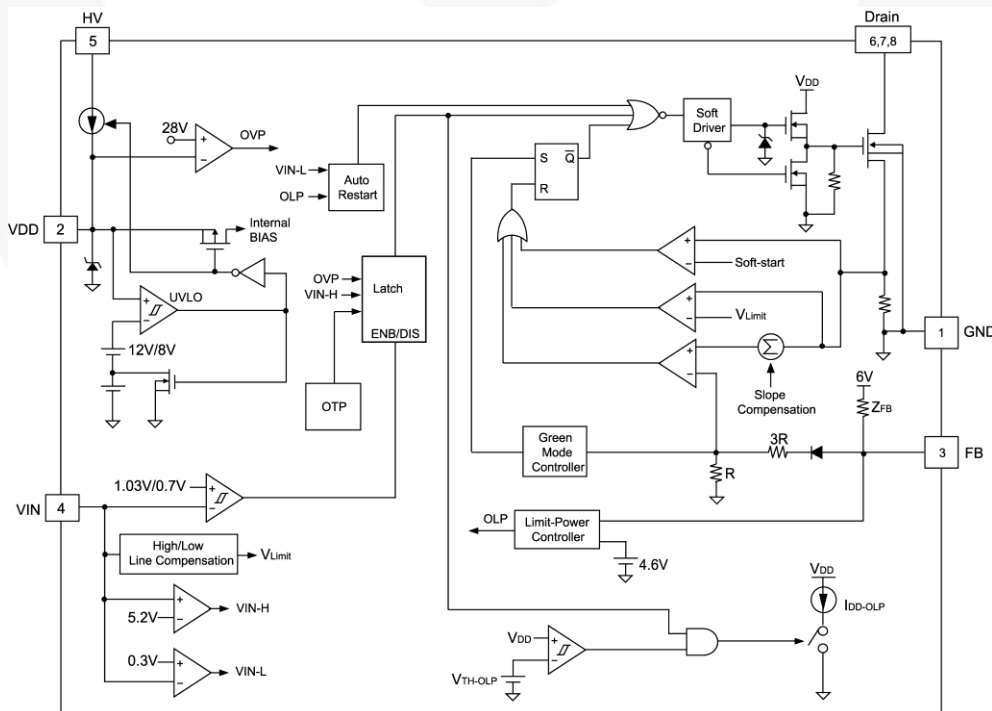
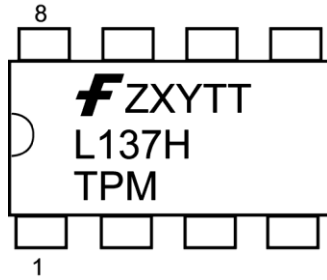


Figure 2. Internal Block Diagram

## Pin Configuration



**F** – Fairchild Logo  
**Z** – Plant Code  
**X** – 1-Digit Year Code  
**Y** – 1-Digit Week Code  
**TT** – 2-Digit Die Run Code  
**T** – Package Type (N: DIP)  
**P – Y**: Green Package  
**M** – Manufacture Flow Code

Figure 3. Pin Configuration

## Pin Definitions

Pin #	Name	Description
1	GND	<b>Ground.</b> SenseFET source terminal on primary side and internal controller ground.
2	VDD	<b>Power Supply.</b> The internal protection circuit disables PWM output as long as $V_{DD}$ exceeds the OVP trigger point.
3	FB	<b>Feedback.</b> The signal from the external compensation circuit is fed into this pin. The PWM duty cycle is determined in response to the signal on this pin and the internal current-sense signal.
4	VIN	<b>Line-Voltage Detection.</b> The line-voltage detection is used for brownout protection with hysteresis and constant output power limit over universal AC input range. This pin has additional protections that are pull-HIGH latch and pull-low auto recovery, depending on the application.
5	HV	<b>Startup.</b> For startup, this pin is pulled HIGH to the line input or bulk capacitor via resistors.
6	Drain	<b>SenseFET Drain.</b> High-voltage power SenseFET drain connection.
7	Drain	<b>SenseFET Drain.</b> High-voltage power SenseFET drain connection.
8	Drain	<b>SenseFET Drain.</b> High-voltage power SenseFET drain connection.

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V <sub>DRAIN</sub>	Drain Pin Voltage <sup>(5, 6)</sup>		700	V
I <sub>DM</sub>	Drain Current Pulsed <sup>(7)</sup>		12	A
E <sub>AS</sub>	Single Pulsed Avalanche Energy <sup>(8)</sup>		230	mJ
V <sub>VDD</sub>	DC Supply Voltage		30	V
V <sub>FB</sub>	FB Pin Input Voltage	-0.3	7.0	V
V <sub>VIN</sub>	VIN Pin Input Voltage	-0.3	7.0	V
V <sub>HV</sub>	HV Pin Input Voltage		700	V
P <sub>D</sub>	Power Dissipation (T <sub>A</sub> < 50°C)		1.5	W
θ <sub>JA</sub>	Junction-to-Air Thermal Resistance		80	°C/W
Ψ <sub>JT</sub>	Junction-to-Top Thermal Resistance <sup>(9)</sup>		35	°C/W
T <sub>J</sub>	Operating Junction Temperature		+150	°C
T <sub>STG</sub>	Storage Temperature Range	-55	150	°C
T <sub>L</sub>	Lead Temperature (Wave Soldering or IR, 10 Seconds)		+260	°C
ESD	Electrostatic Discharge Capability, All Pins Except HV Pin <sup>(10)</sup>	Human Body Model: JESD22-A114	4.5	kV
		Charged Device Model: JESD22-C101	1.5	

### Notes:

- All voltage values, except differential voltages, are given with respect to the network ground terminal.
- Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device.
- Non-repetitive rating: Pulse width is limited by maximum junction temperature.
- L = 51mH, starting T<sub>J</sub> = 25°C.
- Measured on the package top surface.
- All pins including HV pin: HBM=1kV, CDM=1.25kV

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
T <sub>A</sub>	Operating Ambient Temperature		-40		+105	°C

## Electrical Characteristics

$V_{DD}=15V$ ,  $T_A=25^\circ C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>SenseFET Section<sup>(11)</sup></b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V$	700			V
$I_{DSS}$	Zero-Gate-Voltage Drain Current	$V_{DS} = 700V$ , $V_{GS} = 0V$		0.5	50.0	$\mu A$
		$V_{DS} = 560V$ , $V_{GS} = 0V$ , $T_A = 125^\circ C$		1	200	
$R_{DS(ON)}$	Drain-Source On-State Resistance <sup>(12)</sup>	$V_{GS} = 10V$ , $I_D = 0.5A$		4.00	4.75	$\Omega$
$C_{ISS}$	Input Capacitance	$V_{GS} = 0V$ , $V_{DS} = 25V$ , $f = 1MHz$		315	410	pF
$C_{OSS}$	Output Capacitance	$V_{GS} = 0V$ , $V_{DS} = 25V$ , $f = 1MHz$		47	61	pF
$C_{RSS}$	Reverse Transfer Capacitance	$V_{GS} = 0V$ , $V_{DS} = 25V$ , $f = 1MHz$		9	14	pF
$t_{d(on)}$	Turn-On Delay Time	$V_{DS} = 350V$ , $I_D = 1.0A$		11.2	33.0	ns
$t_r$	Rise Time	$V_{DS} = 350V$ , $I_D = 1.0A$		34	78	ns
$t_{d(off)}$	Turn-Off Delay Time	$V_{DS} = 350V$ , $I_D = 1.0A$		28.2	67.0	ns
$t_f$	Fall Time	$V_{DS} = 350V$ , $I_D = 1.0A$		32	74	ns
<b>V<sub>DD</sub> Section</b>						
$V_{OP}$	Continuously Operating Voltage				22	V
$V_{DD-ON}$	Start Threshold Voltage		11	12	13	V
$V_{DD-OFF}$	Minimum Operating Voltage		7	8	9	V
$I_{DD-ST}$	Startup Current	$V_{DD-ON} - 0.16V$			30	$\mu A$
$I_{DD-OP}$	Operating Supply Current	$V_{DD} = 15V$ , $V_{FB} = 3V$	3.0	3.5	4.0	mA
$I_{DD-BM}$	Green-Mode Operating Supply Current	$V_{FB} = V_{FB-G}$		2		mA
$I_{DD-OLP}$	Internal Sink Current	$V_{TH-OLP} + 0.1V$	30	60	90	$\mu A$
$V_{TH-OLP}$	$I_{DD-OLP}$ Off Voltage		5	6	7	V
$V_{DD-OVP}$	$V_{DD}$ Over-Voltage Protection		27	28	29	V
$t_{D-VDDOVP}$	$V_{DD}$ Over-Voltage Protection Debounce Time		75	130	200	$\mu s$
<b>HV Section</b>						
$I_{HV}$	Maximum Current Drawn from HV Pin	HV 120V <sub>DC</sub> , $V_{DD} = 0V$ with 10 $\mu F$	1.5	3.5	5.0	mA
$I_{HV-LC}$	Leakage Current After Startup	HV = 700V, $V_{DD} = V_{DD-OFF} + 1V$		1	20	$\mu A$
<b>Oscillator Section</b>						
$f_{OSC}$	Frequency in Nominal Mode	Center Frequency	94	100	106	kHz
$f_{OSC-G}$	Green-Mode Frequency		14	18	22	kHz
$D_{MAX}$	Maximum Duty Cycle			85		%
$f_{DV}$	Frequency Variation vs. $V_{DD}$ Deviation	$V_{DD} = 9V$ to $22V$			5	%
$f_{DT}$	Frequency Variation vs. Temperature Deviation <sup>(11)</sup>	$T_A = -40$ to $+105^\circ C$			5	%

Continued on the following page...

## Electrical Characteristics (Continued)

$V_{DD}=15V$ ,  $T_A=25^\circ C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>V<sub>IN</sub> Section</b>						
$V_{IN-ON}$	PWM Turn-on Threshold Voltage		0.98	1.03	1.08	V
$V_{IN-RL}$	Release Latch Voltage		0.65	0.70	0.75	V
$V_{IN-H}$	Pull HIGH Latch Trigger Level		4.9	5.2	5.5	V
$t_{IN-H}$	Pull HIGH Latch Debounce Time			100		μs
$V_{IN-L}$	Pull LOW Auto Recovery Trigger Level		0.2	0.3	0.4	V
<b>Feedback Input Section</b>						
$A_V$	FB Voltage to Current-Sense Attenuation			1/4.0		V/V
$Z_{FB}$	Input Impedance			9.5		kΩ
$V_{FB-OPEN}$	Output High Voltage		5			V
$V_{FB-OLP}$	FB Open-Loop Trigger Level		4.4	4.6	4.8	V
$t_{d-OLP}$	Delay Time of FB Pin Open-loop Protection		50	56	59	ms
$V_{FB-N}$	Green-Mode Entry FB Voltage		2.3	2.5	2.7	V
$V_{FB-G}$	Green-Mode Ending FB Voltage			$V_{FB-N} - 0.1$		V
$V_{FB-ZDC}$	Zero Duty Cycle FB Voltage		1.9	2.1	2.3	V

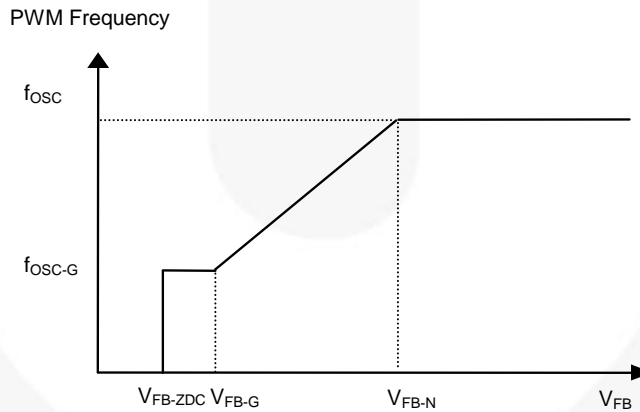


Figure 4.  $V_{FB}$  vs. PWM Frequency

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Current-Sense Section</b>						
$I_{LIM}$ at $V_{IN} = 1.2V$	Peak Current Limit	$V_{IN} = 1.2V$	0.74	0.84	0.94	A
$I_{LIM}$ at $V_{IN} = 3.6V$	Peak Current Limit	$V_{IN} = 3.6V$	0.64	0.74	0.84	A
$t_{SS}$	Period during Soft Startup Time <sup>(11)</sup>		4.5	5.0	5.5	ms
<b>Over-Temperature Protection Section (OTP)</b>						
$T_{OTP}$	Protection Junction Temperature <sup>(11,13)</sup>			142		°C

### Notes:

11. These parameters, although guaranteed, are not 100% tested in production.
12. Pulse test: pulse width  $\leq 300\mu s$ , duty  $\leq 2\%$ .
13. When activated, the output is disabled and the latch is turned off.

## Typical Characteristics

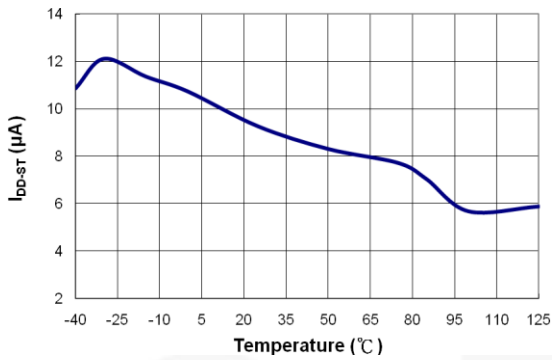


Figure 5. I<sub>DD-ST</sub> vs. Temperature

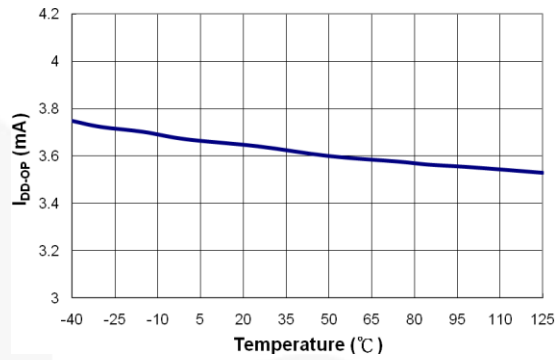


Figure 6. I<sub>DD-OP</sub> vs. Temperature

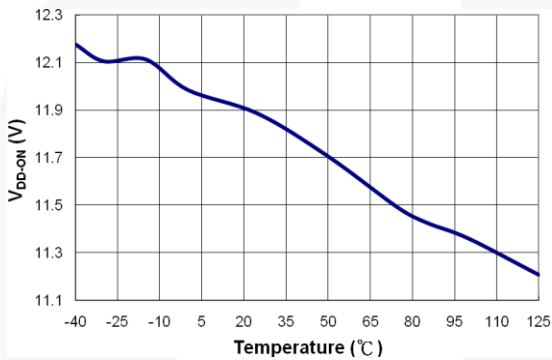


Figure 7. V<sub>DD-ON</sub> vs. Temperature

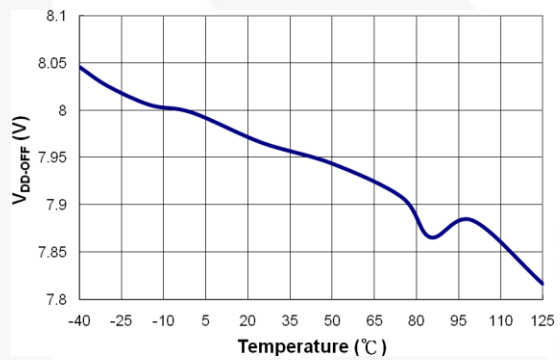


Figure 8. V<sub>DD-OFF</sub> vs. Temperature

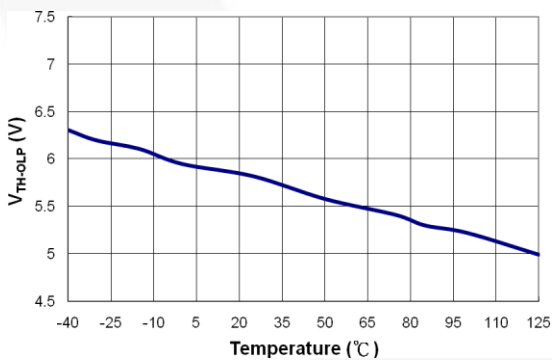


Figure 9. V<sub>TH-OLP</sub> vs. Temperature

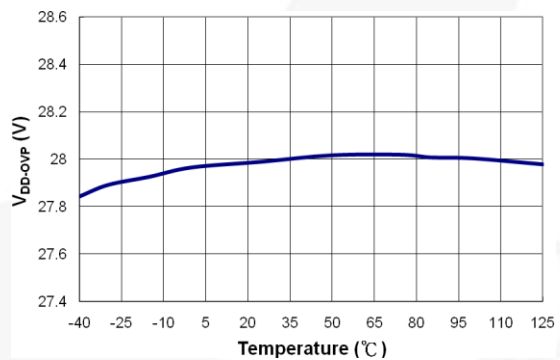


Figure 10. V<sub>DD-OVP</sub> vs. Temperature



## Typical Characteristics

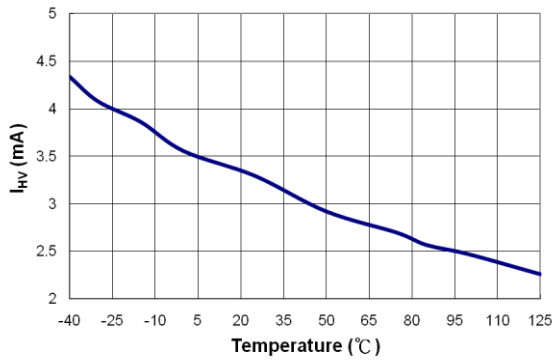


Figure 11. I<sub>HV</sub> vs. Temperature

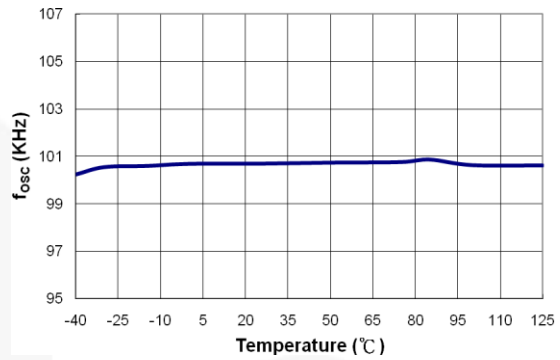


Figure 12. f<sub>osc</sub> vs. Temperature

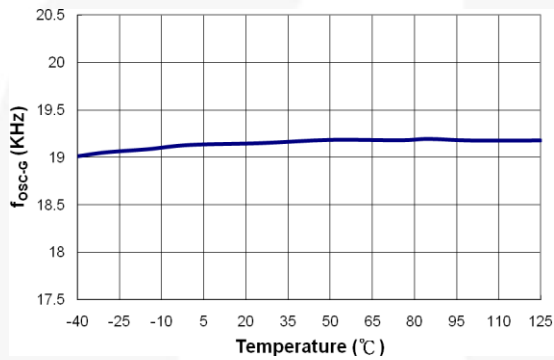


Figure 13. f<sub>osc-G</sub> vs. Temperature

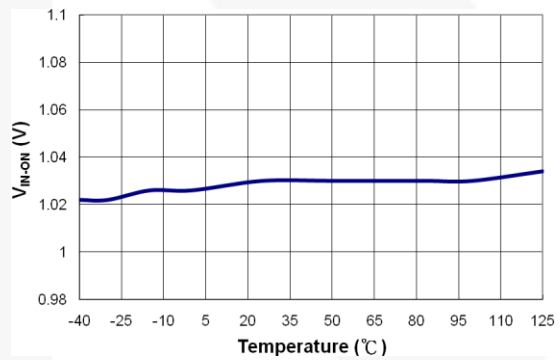


Figure 14. V<sub>IN-ON</sub> vs. Temperature

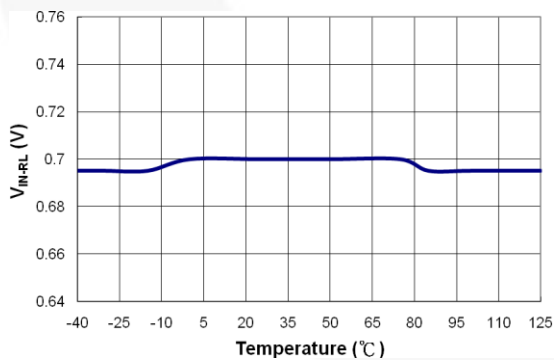


Figure 15. V<sub>IN-RL</sub> vs. Temperature

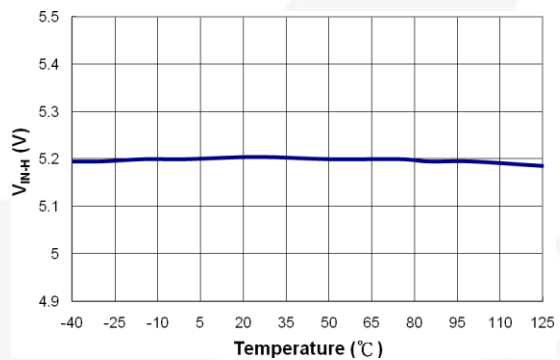


Figure 16. V<sub>IN-H</sub> vs. Temperature

## Typical Characteristics

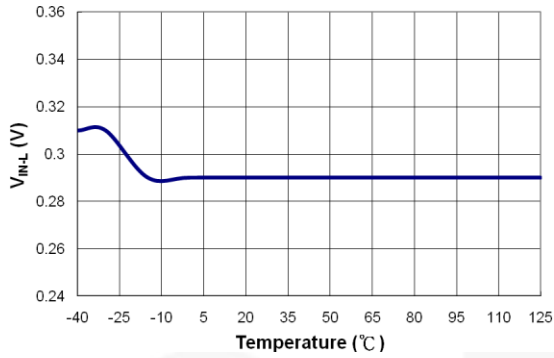


Figure 17. V<sub>IN-L</sub> vs. Temperature

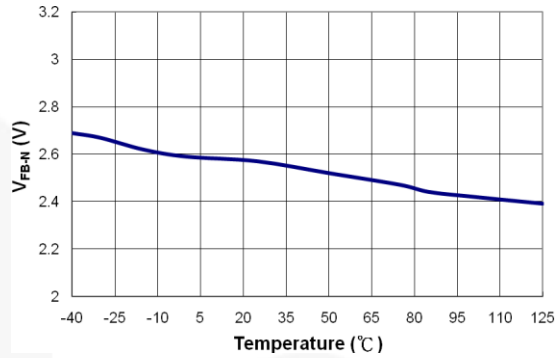


Figure 18. V<sub>FB-N</sub> vs. Temperature

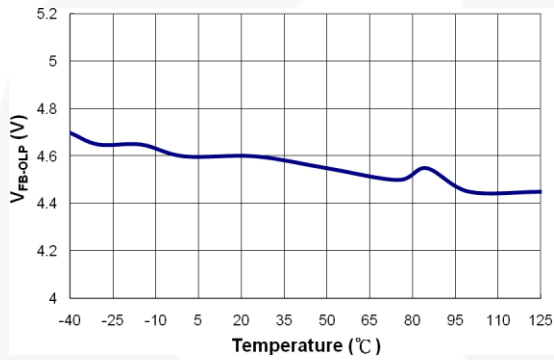


Figure 19. V<sub>FB-OLP</sub> vs. Temperature

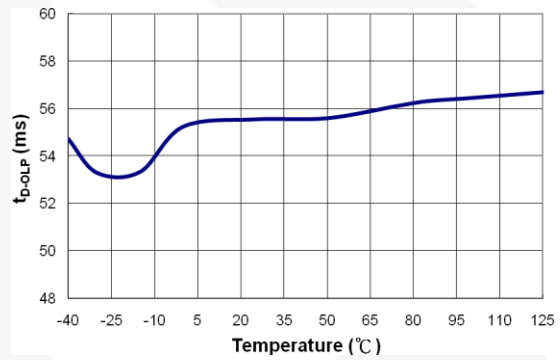


Figure 20. t<sub>D-OLP</sub> vs. Temperature

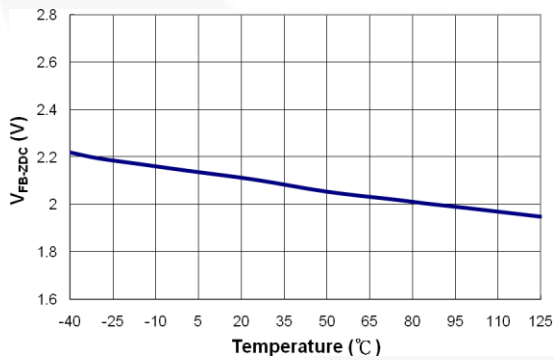


Figure 21. V<sub>FB-ZDC</sub> vs. Temperature

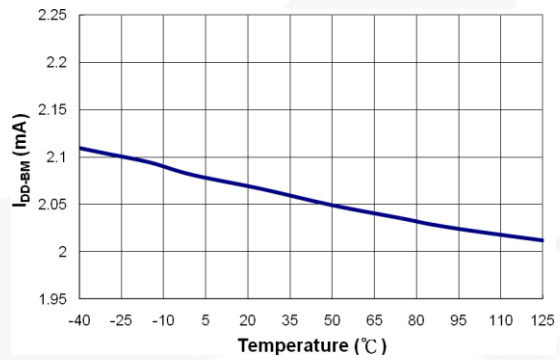


Figure 22. I<sub>DD-BM</sub> vs. Temperature

## Functional Description

### Startup Operation

For startup, the HV pin is connected to the line input or bulk capacitor through the external resistor,  $R_{HV}$ , as shown in Figure 23. Typical startup current drawn from the HV pin is 3.5mA and it charges the  $V_{DD}$  capacitor through the resistor  $R_{HV}$ . The startup current turns off when the  $V_{DD}$  capacitor voltage reaches  $V_{DD-ON}$ . The  $V_{DD}$  capacitor maintains  $V_{DD}$  until the auxiliary winding of the transformer provides the operating current.

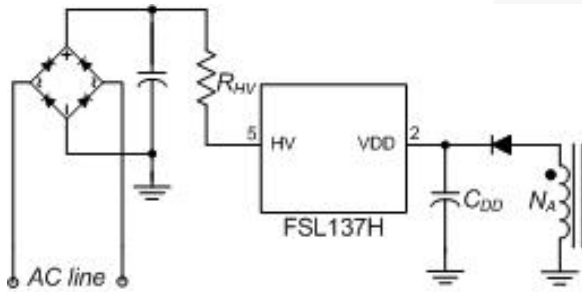


Figure 23. Startup Circuit

### Slope Compensation

FSL137H is designed for flyback power converters. The peak-current control is used to optimize system performance. Slope compensation is added to stabilize the current loop. FSL137H inserts a synchronized, positively sloped ramp at each switching cycle.

### Soft-Start

The FSL137H has internal soft-start circuit that slowly increases the SenseFET current after startup. The typical soft-start time is 5ms during which the  $V_{Limit}$  level is increased in six steps to smoothly establish the required output voltage, as shown in Figure 24. It also helps to prevent transformer saturation and reduce the stress on the secondary diode during startup.

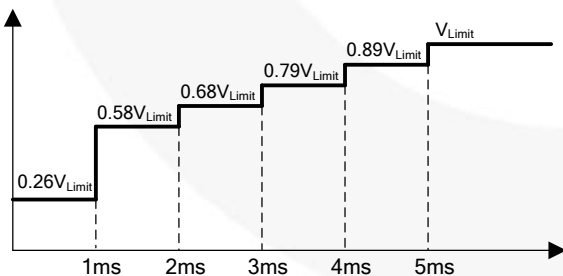


Figure 24. Soft-Start Function

### Green-Mode Operation

The FSL137H uses feedback voltage ( $V_{FB}$ ) as an indicator of the output load and modulates the PWM frequency, as shown in Figure 25, such that the switching frequency decreases as load decreases. In heavy load conditions, the switching frequency is 100kHz. Once  $V_{FB}$  decreases below  $V_{FB-N}$  (2.5V), the PWM frequency starts to linearly decrease from 100kHz to 18kHz to reduce the switching losses. As  $V_{FB}$  decreases below  $V_{FB-G}$  (2.4V), the switching frequency is fixed at 18kHz and FSL137H enters into “deep” green mode to reduce the standby power consumption. As  $V_{FB}$  decreases below  $V_{FB-ZDC}$  (2.1V), FSL137H enters into burst-mode operation. When  $V_{FB}$  drops below  $V_{FB-ZDC}$ , FSL137H stops switching and the output voltage starts to drop, which causes the feedback voltage to rise. Once  $V_{FB}$  rises above  $V_{FB-ZDC}$ , switching resumes. Burst mode alternately enables and disables switching, thereby reducing switching loss to improve power saving, as shown in Figure 26.

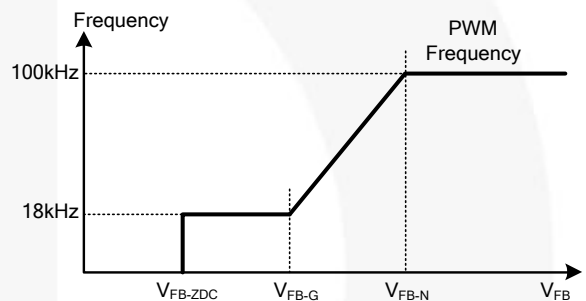


Figure 25. PWM Frequency

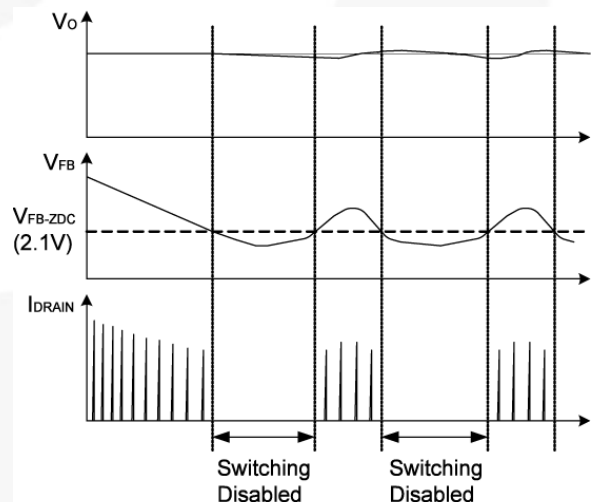


Figure 26. Burst Mode Operation

### Constant Power Control

To limit the output power of the converter constantly, high/low line compensation is included. Sensing the converter input voltage through the VIN pin, the high/low line compensation function generates a relative peak-current-limit threshold voltage for constant power control, as shown in Figure 27.

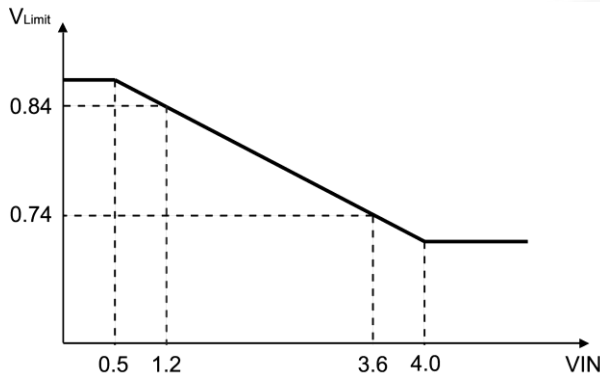


Figure 27. Constant Power Control

### Protections

The FSL137H provides full protection functions to prevent the power supply and the load from being damaged. The protection features include:

#### Latch / Auto Recovery Function

The FSL137H provides additional protections by the VIN pin, such as pull-HIGH latch and pull-LOW auto recovery that depend on the application. As shown in Figure 28, when V<sub>IN</sub> is higher than 5.2V, FSL137H is latched until the V<sub>DD</sub> is discharged. FSL137H is in auto recovery when V<sub>IN</sub> is lower than 0.3V.

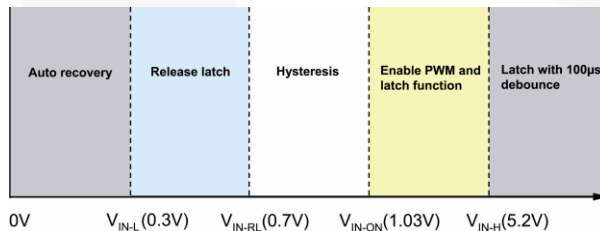


Figure 28. VIN Pin Function

#### Open-Loop / Overload Protection (OLP)

When the upper branch of the voltage divider for the shunt regulator (KA431 shown) is broken, as shown in Figure 29, or over current or output short occurs. There is no current flowing through the opto-coupler transistor, which pulls up the feedback voltage to 6V. When the feedback voltage is above 4.6V for longer than 56ms, OLP is triggered. This protection is also triggered when the SMPS output drops below the nominal value longer than 56ms due to the overload condition.

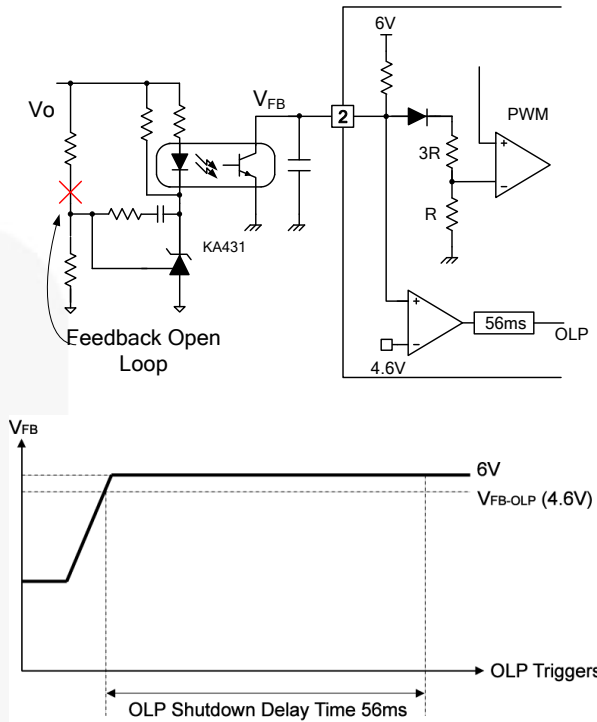


Figure 29. OLP Operation

#### V<sub>DD</sub> Over-Voltage Protection (OVP)

V<sub>DD</sub> over-voltage protection prevents IC damage caused by over voltage on the V<sub>DD</sub> pin. The OVP is triggered when V<sub>DD</sub> reaches 28V. It has a debounce time (typically 130µs) to prevent false trigger by switching noise.

#### Over-Temperature Protection (OTP)

The SenseFET and the control IC are integrated, making it easier to detect the temperature of the SenseFET. When the temperature exceeds approximately 142°C, thermal shutdown is activated.

## Typical Application Circuit

Application	Fairchild Devices	Input Voltage Range	Output
Adapter	FSL137H	90~264Vac	12V/1A (12W)

### Features

- High efficiency (>77.76% at full load) meeting Energy Star V2.0 regulation with enough margin
- Standby power <100mW at no-load condition
- Provides full protection functions:

OVP	OTP	OLP	VIN-H	VIN-L
Latch	Latch	Auto restart	Latch	Auto restart

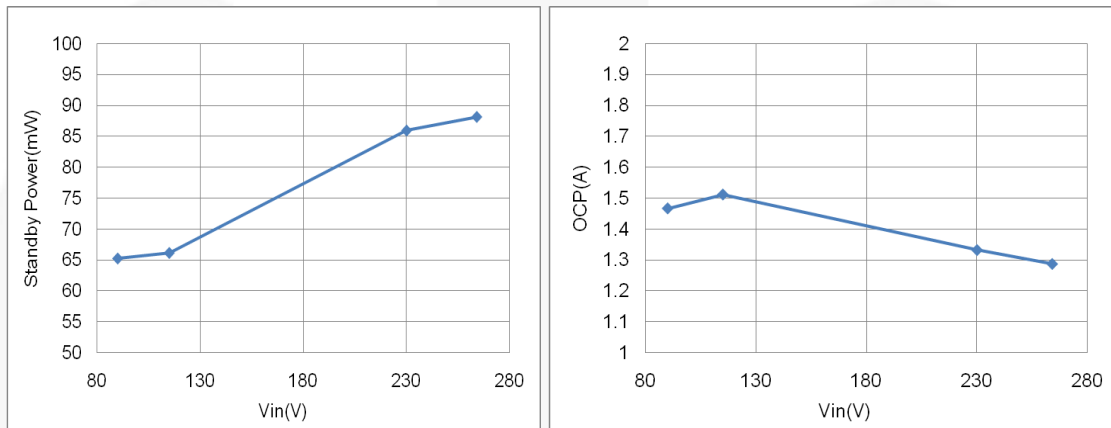


Figure 30. Measured Standby Power and OCP

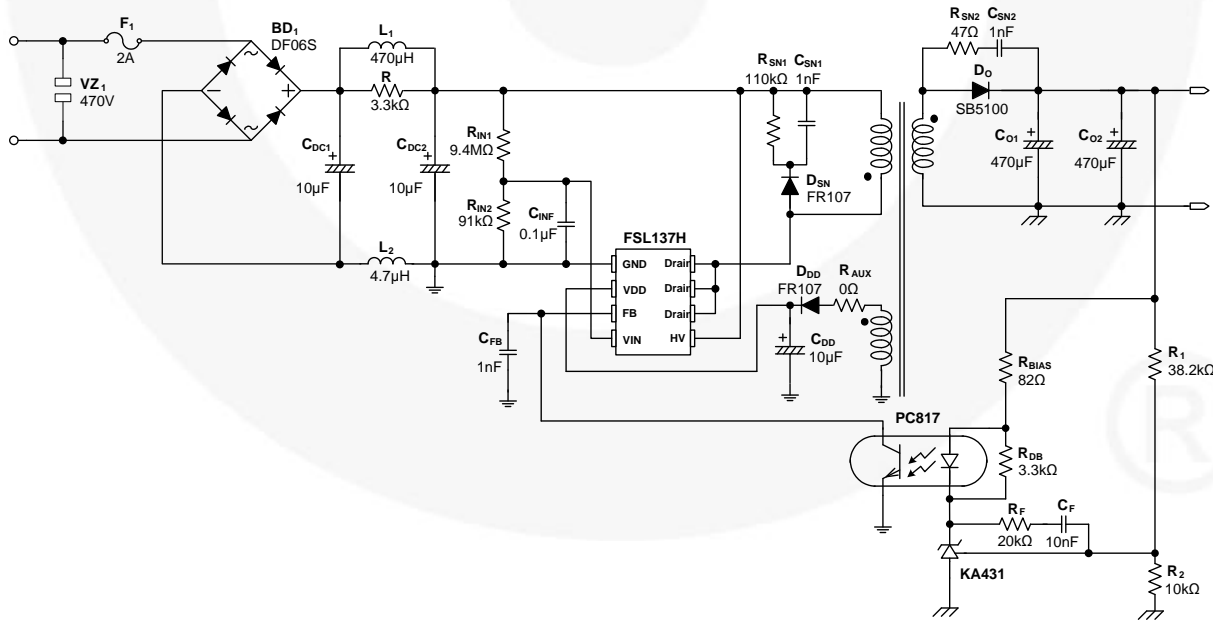


Figure 31. Schematic of Typical Application Circuit

## Typical Application Circuit (Continued)

### Transformer Specification

- Core: EE16
- Bobbin: EE16

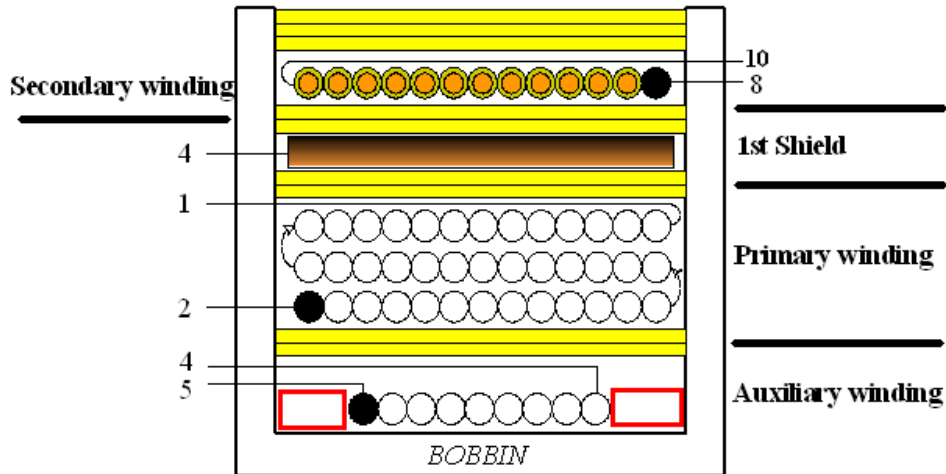
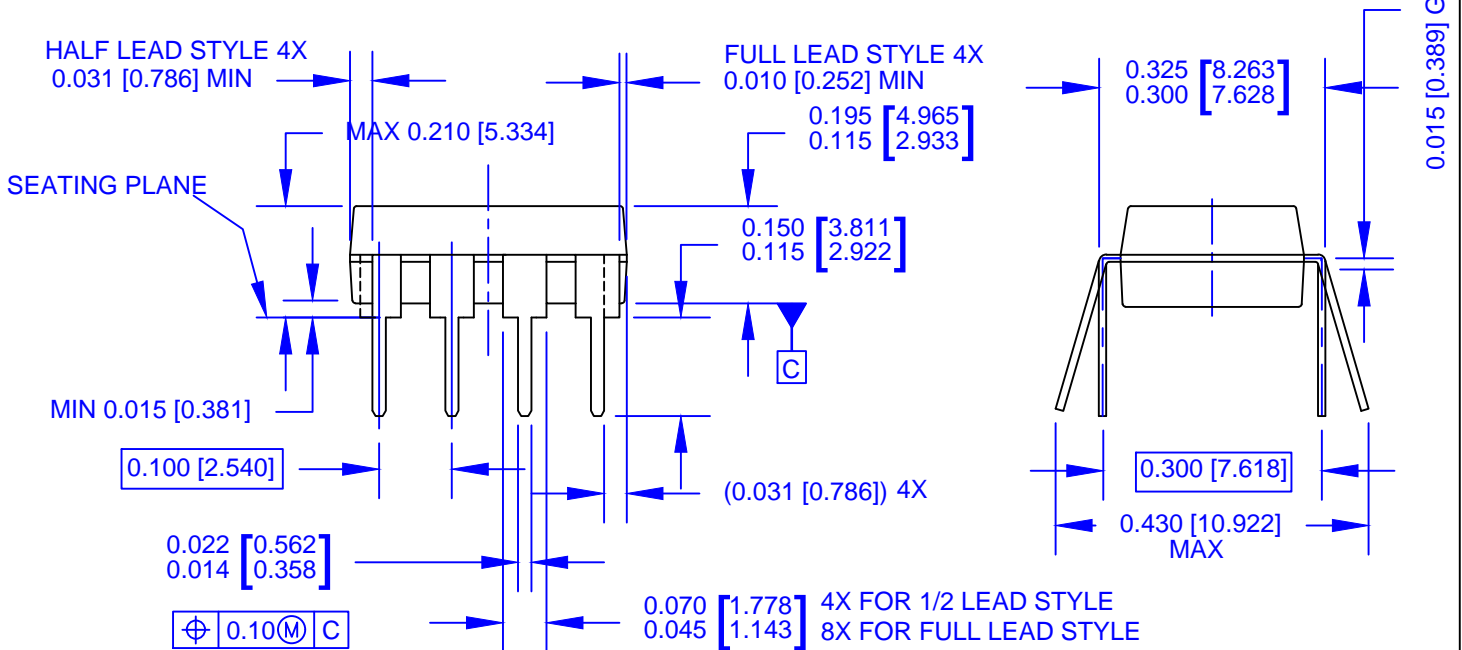
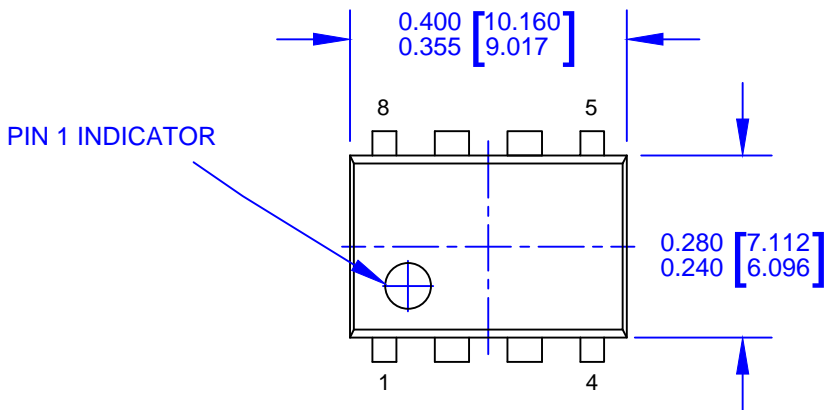


Figure 32. Transformer Diagram

NO.	TERMINAL		WIRE	Ts
	S	F		
W1	5	4	2UEW 0.3*1	13
W2	2	1	2UEW 0.26*1	75
W3	4	-	COPPER SHIELD	1.2
W4	8	10	TEX-E 0.35*1	13
			CORE ROUNDING TAPE	3
Primary-Side Inductance=600μH ± 5%				
Primary-Side Effective Leakage<20μH ± 5%				



NOTES:

- A) THIS PACKAGE CONFORMS TO JEDEC MS-001 VARIATION BA WHICH DEFINES 2 VERSIONS OF THE PACKAGE TERMINAL STYLE WHICH ARE SHOWN HERE.
- B) CONTROLLING DIMS ARE IN INCHES
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D) DIMENSIONS AND TOLERANCES PER ASME Y14.5M-2009
- E) DRAWING FILENAME AND REVISION: MKT-N08MREV2.



ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5817-1050

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local  
Sales Representative